SiHB21N60EF

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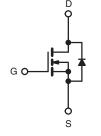
Vishay Siliconix

EF Series Power MOSFET with Fast Body Diode

PRODUCT SUMMARY						
V _{DS} (V) at T _J max.	650					
R _{DS(on)} max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.176				
Q _g (Max.) (nC)	84					
Q _{gs} (nC)	14					
Q _{gd} (nC)	24					
Configuration	Single					

D²PAK (TO-263)





N-Channel MOSFET

FEATURES

- Fast body diode MOSFET using E series technology
- Reduced $t_{rr},\,Q_{rr},\,and\,I_{RRM}$
- Low figure-of-merit (FOM): Ron x Qg
- Low input capacitance (C_{iss})
- Increased robustness due to low Q_{rr}
- Ultra low gate charge (Q_g)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Telecommunications
 - Server and telecom power supplies
- Lighting
 - High intensity discharge (HID)
 - Light emitting diodes (LEDs)
- Consumer and computing
- ATX power supplies
- Industrial
 - Welding
- Battery chargersRenewable energy
 - Solar (PV inverters)
- Switch mode power suppliers (SMPS)
- Applications using the following topologies
 - LLC
 - Phase shifted bridge (ZVS)
 - 3-level inverter
 - AC/DC bridge

	ORDERING INFORMATION	
ſ	Package	D ² PAK (TO-263)
I	Lead (Pb)-free and Halogen-free	SiHB21N60EF-GE3

ABSOLUTE MAXIMUM RATINGS (T _C =	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage	V _{DS}	600	v		
Gate-Source Voltage	V _{GS}	± 30	V		
Continuous Drain Current (T. 150 °C)	V	T _C = 25 °C T _C = 100 °C		21	
Continuous Drain Current ($T_J = 150 \ ^\circ$ C)	V _{GS} at 10 V	T _C = 100 °C	ID	14	А
Pulsed Drain Current ^a	I _{DM}	53			
Linear Derating Factor		1.8	W/°C		
Single Pulse Avalanche Energy ^b	E _{AS}	367	mJ		
Maximum Power Dissipation		PD	227	W	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55 to +150	°C		
Drain-Source Voltage Slope	125 °C	B (/ I)	70		
Reverse Diode dV/dt ^d	dV/dt	20	V/ns		
Soldering Recommendations (Peak Temperature) ^c		300	°C		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. $V_{DD} = 50$ V, starting $T_J = 25$ °C, L = 28.2 mH, $R_g = 25 \Omega$, $I_{AS} = 5.1$ A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D$, dI/dt = 100 A/µs, starting T_J = 25 °C.

S15-0398-Rev. A, 02-Mar-15

1



COMPLIANT HALOGEN

FREE



Vishay Siliconix

THERMAL RESISTANCE RATINGS							
PARAMETER	SYMBOL	TYP.	MAX.	UNIT			
Maximum Junction-to-Ambient	R _{thJA}	-	62	°C/W			
Maximum Junction-to-Case (Drain)	R _{thJC}	- 0.55 ⁻ C/W		0/10			

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static		•			•		
Drain-Source Breakdown Voltage	V _{DS}	V _{GS}	600	-	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, I _D = 1 mA			0.59	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	2.0	-	4.0	V	
Cata Sauraa Laakaga	1		$V_{GS} = \pm 20 V$		-	± 100	nA
Gate-Source Leakage	GSS		$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μA
Zero Gate Voltage Drain Current	I =	V _{DS} =	$\frac{V_{DS} = 480 \text{ V}, \text{ V}_{GS} = 0 \text{ V}}{V_{DS} = 480 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}}$		-	1	μA
Zero Gate voltage Drain Current	I _{DSS}	V _{DS} = 480 \			-	500	μΑ
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 11 A	-	0.153	0.176	Ω
Forward Transconductance	9 _{fs}	V _{DS}	= 30 V, I _D = 11 A	-	7	-	S
Dynamic							
Input Capacitance	C _{iss}		$V_{GS} = 0 V,$	-	2030	-	
Output Capacitance	C _{oss}		V _{DS} = 100 V,	-	105	-	
Reverse Transfer Capacitance	C _{rss}		f = 1 MHz	-	5	-	
Effective output capacitance, energy related ^a	C _{o(er)}		V_{GS} = 0 V, V_{DS} = 0 V to 480 V		86	-	pF
Effective output capacitance, time related ^b	C _{o(tr)}	$V_{GS} = 0$			299	-	
Total Gate Charge	Qg			-	56	84	
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 V$	I _D = 11 A, V _{DS} = 480 V	-	14	-	nC
Gate-Drain Charge	Q _{gd}			-	24	-	
Turn-On Delay Time	t _{d(on)}			-	21	42	
Rise Time	t _r	V _{DD} =	= 480 V, I _D = 11 A	-	31	62	
Turn-Off Delay Time	t _{d(off)}	$R_g = 1$	9.1 Ω, V _{GS} = 10 V	-	59	89	ns
Fall Time	t _f			-	27	54	
Gate Input Resistance	Rg	f = 1	MHz, open drain	-	0.56	-	Ω
Drain-Source Body Diode Characteristic	S						
Continuous Source-Drain Diode Current	I _S	MOSFET sym showing the	MOSFET symbol		-	21	
Pulsed Diode Forward Current	I _{SM}	integral revers p - n junction	\smile	-	-	53	A
Diode Forward Voltage	V _{SD}	T _J = 25 °	C, I _S = 11 A, V _{GS} = 0 V	-	0.9	1.2	V
Reverse Recovery Time	t _{rr}			-	135	270	ns
Reverse Recovery Charge	Q _{rr}		5 °C, $I_F = I_S = 11 \text{ A}$,	-	0.76	1.52	μC
Reverse Recovery Current	I _{RRM}	dl/dt = 100 A/µs, V _R = 25 V		-	11	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} .



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

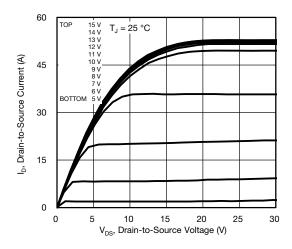


Fig. 1 - Typical Output Characteristics, T_J = 25 °C

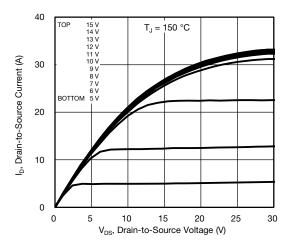


Fig. 2 - Typical Output Characteristics, T_J = 150 °C

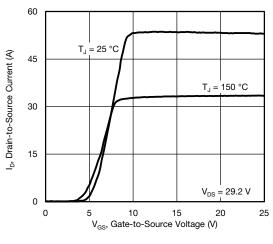


Fig. 3 - Typical Transfer Characteristics

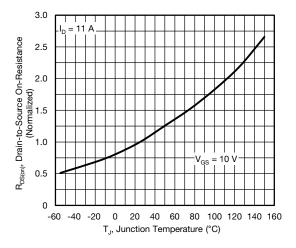


Fig. 4 - Normalized On-Resistance vs. Temperature

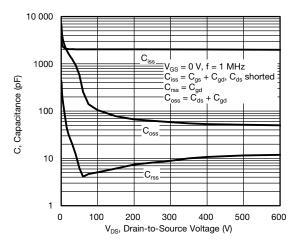
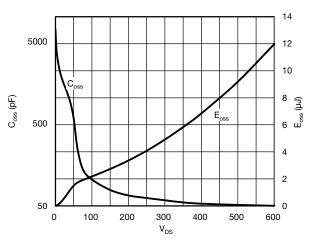
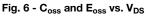


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





3

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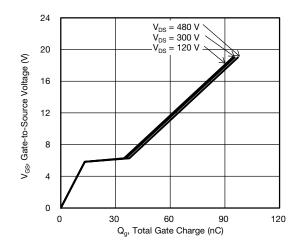


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

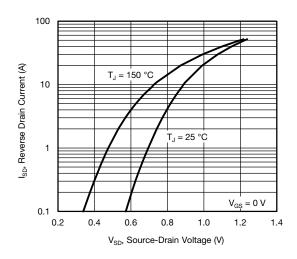


Fig. 8 - Typical Source-Drain Diode Forward Voltage

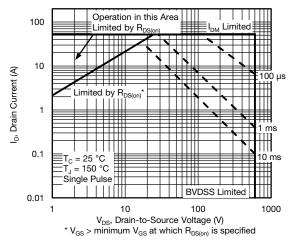


Fig. 9 - Maximum Safe Operating Area

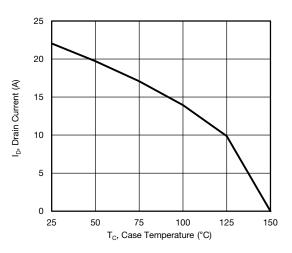


Fig. 10 - Maximum Drain Current vs. Case Temperature

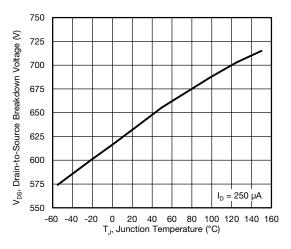


Fig. 11 - Typical Drain-to-Source Voltage vs. Temperature

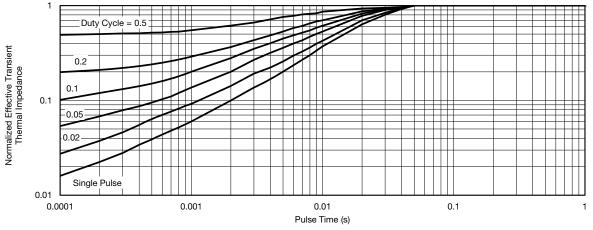
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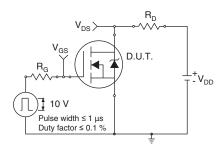


Fig. 13 - Switching Time Test Circuit

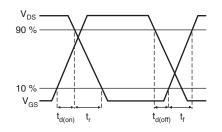


Fig. 14 - Switching Time Waveforms

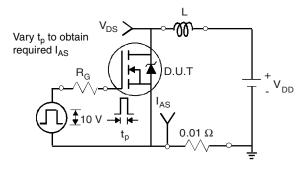


Fig. 15 - Unclamped Inductive Test Circuit

S15-0398-Rev. A, 02-Mar-15

Fig. 16 - Unclamped Inductive Waveforms

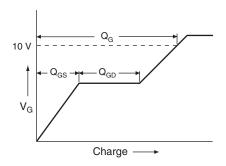
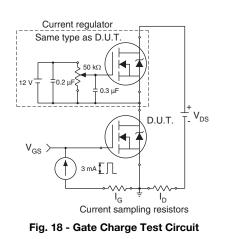


Fig. 17 - Basic Gate Charge Waveform

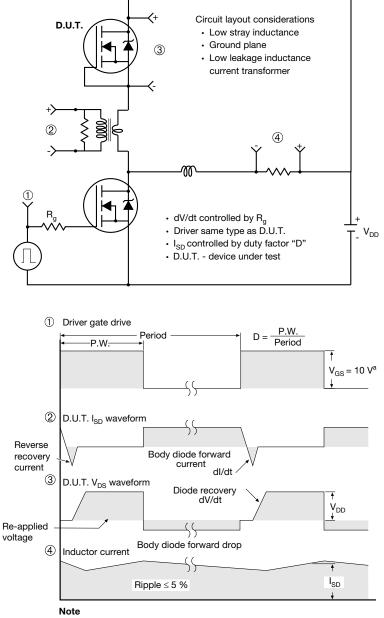


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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 19 - For N-Channel

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H

A1

B

Gauge plane

L3

Detail "A" Rotated 90° CW scale 8:1

0° to 8° **Vishay Siliconix**

Seating plane

TO-263AB (HIGH VOLTAGE)

∕3 ⁄4 A

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Detail A

(Datum A)

D

 $\underline{4}$ 11

	2	-	Y 2 x b2 2 x b ⊕ 0.010 @ A(■ ating 5 b1, b b1, b b1, b c) c) c) c) c) c) c) c) c) c)	$\begin{array}{c} c_{1} \\ c_{1} \\ c_{2} \\ c_{3} \\ c_{4} \\ c_{5} \\ c_{7} \\$	a - 1		Ū.	1 <u>4</u>	
	MILLIN	IETERS	INC	HES			MILLIMETERS INCHES		HES	
DIM.	MIN.	MAX.	MIN.	MAX.		DIM.	MIN.	MAX.	MIN.	MAX.
А	4.06	4.83	0.160	0.190		D1	6.86	-	0.270	-
				0.010		-		10.07	0.000	0.420
A1	0.00	0.25	0.000	0.010		E	9.65	10.67	0.380	0.120
A1 b	0.00 0.51	0.25 0.99	0.000	0.010		E1	9.65 6.22	- 10.67	0.380	-
							6.22	- 10.67 - BSC	0.245	- BSC
b	0.51	0.99	0.020	0.039		E1	6.22	-	0.245	-
b b1	0.51 0.51	0.99 0.89	0.020 0.020	0.039 0.035		E1 e	6.22 2.54	- BSC	0.245	-) BSC
b b1 b2	0.51 0.51 1.14	0.99 0.89 1.78	0.020 0.020 0.045	0.039 0.035 0.070		E1 e H	6.22 2.54 14.61	- BSC 15.88	0.245 0.100 0.575	-) BSC 0.625
b b1 b2 b3	0.51 0.51 1.14 1.14	0.99 0.89 1.78 1.73	0.020 0.020 0.045 0.045	0.039 0.035 0.070 0.068		E1 e H L	6.22 2.54 14.61 1.78	- BSC 15.88 2.79	0.245 0.100 0.575 0.070	- 0 BSC 0.625 0.110
b b1 b2 b3 c	0.51 0.51 1.14 1.14 0.38	0.99 0.89 1.78 1.73 0.74	0.020 0.020 0.045 0.045 0.015	0.039 0.035 0.070 0.068 0.029		E1 e H L L1	6.22 2.54 14.61 1.78 - -	- BSC 15.88 2.79 1.65	0.245 0.100 0.575 0.070 - -	- 0 BSC 0.625 0.110 0.066
b b1 b2 b3 c c1	0.51 0.51 1.14 1.14 0.38 0.38	0.99 0.89 1.78 1.73 0.74 0.58	0.020 0.020 0.045 0.045 0.015 0.015	0.039 0.035 0.070 0.068 0.029 0.023		E1 e H L L1 L2	6.22 2.54 14.61 1.78 - -	- BSC 15.88 2.79 1.65 1.78	0.245 0.100 0.575 0.070 - -	- 0 BSC 0.625 0.110 0.066 0.070

Α

Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

2. Dimensions are shown in millimeters (inches).

3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.

4. Thermal PAD contour optional within dimension E, L1, D1 and E1.

5. Dimension b1 and c1 apply to base metal only.

6. Datum A and B to be determined at datum plane H.

7. Outline conforms to JEDEC outline to TO-263AB.



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1



RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



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